Amendments to the Claims:

This listing of claims will replace all prior versions and listings of claims in the application.

Listing of Claims:

1-35. (Canceled)

36. (Original) A pFET synapse transistor, comprising:

a p- doped substrate;

a first n- well and a second n- well disposed in said substrate;

a first p+ doped region disposed in said first n- well forming a source and a second p+ doped region disposed in said first n- well forming a drain;

a channel disposed in said first n- well between said source and said drain;

a third p+ doped region and a fourth p+ doped region disposed in said second n- well, said third p+ region and said fourth p+ region together forming a tunneling junction;

a layer of gate oxide disposed above said channel, said first n- well and said second n- well;

a polysilicon floating gate disposed above said layer of gate oxide;

a source contact terminal electrically coupled to said source;

a drain contact terminal electrically coupled to said drain; and

a well contact terminal electrically coupled to said second n- well.

37. (Original) A pFET synapse transistor in accordance with claim 36, wherein said third p+ doped region and said fourth p+ doped region are shorted together with a conductive layer which forms a bridge over said floating gate.

38. (Original) A pFET synapse transistor in accordance with claim 37, wherein said well contact terminal is strapped to said third p+ doped region and said fourth p+ doped region.

39. (Original) A pFET synapse transistor in accordance with claim 38, wherein said transistor is formed with a single layer of conductive polysilicon.

40. (Original) A pFET synapse transistor in accordance with claim 36 fabricated using a standard CMOS process.

41-43. (Canceled)